Moore4Medical WP4 Next generation ultrasound



Work package leader: Vincent Henneken



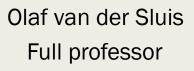
TUE – Eindhoven University of Technology





Shivraj Karewar Postdoctoral researcher

Johan Hoefnagels Associate professor





Jaap den Toonder (WP2) Full professor



Building Gemini at the Eindhoven University of Technology campus, housing of the state-of-the-art Microfab/lab and the Multiscale lab.





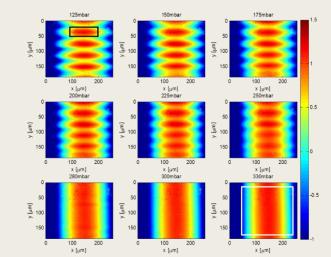
TUE

- University, concept creation. Two research units are involved:
 - Microsystems (MS) WP2
 - Mechanics of Materials (MoM) WP4

Mechanics of Materials

- Thin films mechanics, multi-scale mechanics
- Numerical methods: nonlinear finite elements, discrete particle simulations such as Molecular Dynamics
- <u>https://www.tue.nl/en/research/research-groups/mechanics-of-materials/</u>





Microsystems

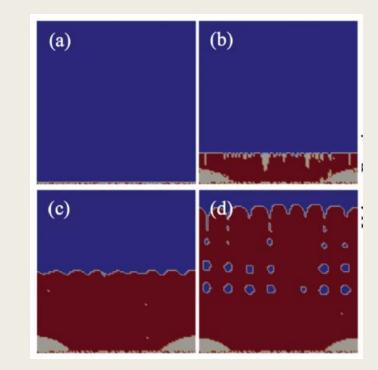
• tbd



TUE contribution WP4

MoM section:

- T4.2: Prediction of residual stresses in low-frequency CMUTs based on discrete particle simulations of thin film deposition processes. This is especially critical for low frequency CMUTs where the membranes are very large and suspending very small gap. The simulations will be performed by discrete particle techniques, such as molecular dynamics.
- Partners: PEN, TUD



Example of simulation of PVD deposition process (Stewart & Spearot, 2018)



STMicroelectronics key contacts



Fabio Quaglia ST project leader





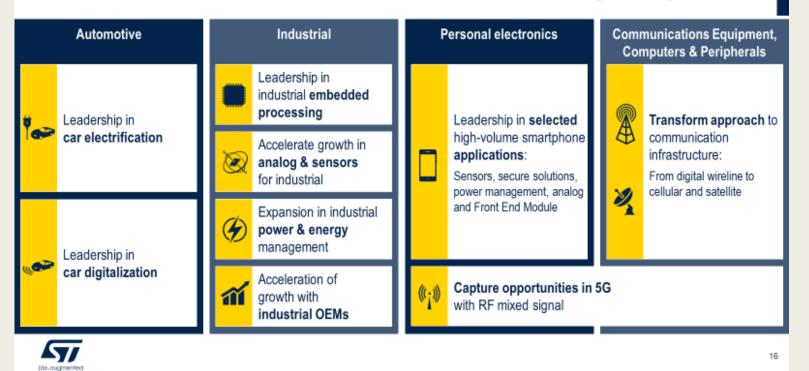
Andrea di Matteo ST project coordinator

STMicroelectronics is one of the world's largest semiconductor companies with net revenues of US\$ 9.56 billion in 2019, with a operating margin of 38.7 % and a net income of US\$ 1.03 billion. Offering one of the industry's broadest product portfolios, ST serves customers across the spectrum of electronics applications with innovative semiconductor solutions by leveraging its vast array of technologies, design expertise and combination of intellectual property portfolio, strategic partnerships and manufacturing strength.



STMicroeletronics

Our strategic objectives



ST-I R&D infrastructures includes:

- Si process technology laboratories in Agrate Brianza (MB) / Cornaredo (MI), fully equipped with simulation tools and equipments for on wafer and in package device characterization and testing and for physical analyses
- Packaging technology laboratories in Agrate Brianza (MB), equipped with simulation and testing tools
- Integrated circuits design and verification tools
- Laboratories for electronic system development, characterization and testing
- Tools for algorithms development in electronic systems

- 1. ENIAC KET 2012: LAB4MEMS "LAB FAB for smart sensors and actuators MEMS"
- 2. ENIAC KET 2013: LAB4MEMS II "Micro-Optical MEMS, micro-mirrors and picoprojectors"
- 3. H2020 ICT-03-2016: INSPEX "Integrated Smart Spatial Exploration System".
- 4. H2020 ECSEL IA Project Arrowhead-Tools H2020 ECSEL IA Project 826452, 2018.
- 5. ENIAC Call 2012-1 DeNeCor "Devices for NeuroControl and NeuroRehabilitation"

STMicroelecronics contribution into WP4

- PMUT technology and process flow definition
- PMUT wafer micro-fabrication
- PMUT electro-mechanical test (Impedance spectroscopy, Laser Doppler Vibrometer)
- ASIC design and realization (BCD or CMOS technology)
- PMUT and ASIC dice assembly: electronic device packaging



MSD Laboratory – University of Florence (UniFI)



Piero Tortoli UniFi unit leader



Enrico Boni Design group leader





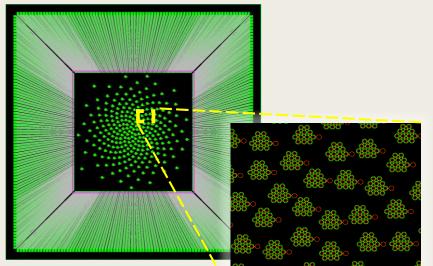
The Microelectronics Sytems Design (MSD) Laboratory is located in the School of Engineering, on the top of a hill looking at Florence

MSD Lab capabilities in M4M

- Biomedical systems design and implementation
- Custom ultrasound systems development
- Ultrasound open scanner development
- Development of innovative Imaging and Doppler methods
- Development of innovative ultrasound probes



ULA-OP: 64-channel open scanner



CMUT 2D-spiral array probe



UniFI planned contribution

UniFI will contribute to the design of:

- PMUT transducer arrays (functionality, geometry, n. of elements, center frequency, pitch and other relevant parameters)
- ASIC front-end



UniFI will develop a special version of ULA-OP 256 (256-channel open platform) capable of driving the new M4M PMUT arrays

We'll mostly work together with:

- STMicroelectronics
- University of RomaTRE
- University of Pavia

But we look forward to new partners!



University of Pavia (UniPV)



Andrea Mazzanti Professor



Piero Malcovati Professor



Edoardo Bonizzoni Professor



Lara Novaresi Research Grant





The University of Pavia (UniPV) is one of the oldest in Europe, founded in 825. Many renowned humanists and scientists studied and taught at the Alma Ticinensis Universitas, such as Cardano, the inventor of the Cardanic joint, and Alessandro Volta, the inventor of electric battery. Nowadays, the multidisciplinary University of Pavia includes nine faculties with more than one thousand professors, three campuses and hosts more than 20 thousand students.



Department of Electrical, Computer and Biomedical Engineering

- 80 professors with internationally recognized scientific profile
- Research fields: microelectronics, industrial engineering,
- bioengineering and computer science
- 30 research labs, supported by public and private funding
- Tight relation with microelectronics companies
- Studio di Microelectronica: a joint lab between UniPV and STM
- Research staff in microelectronics:
 - 11 Professors, 5 Post-Doc Researchers, 18 Ph. D. Students
- Research topics in microelectronics:
 - Analog and mixed-signal integrated circuits
 - Integrated sensors, microsystems, and MEMS
 - Data converters
 - RF and mm-wave integrated circuits
 - Energy harvesting and power management
 - Non-volatile memories





UniPV Contributions into M4M: WP4

PMUT-based active probe for ultrasound imaging

- Contribution to spec definition
- Design and electrical testing of the front-end TX/RX channel for linear PMUT array
- Design and electrical testing of the front-end TX/RX channel for 2D-PMUT array
- Contribution to tests on demonstrators



UNIROMA3 - Who is who and where



Alessandro Stuart Savoia UNIROMA3 Unit Leader



Alessandro Neri Head of Applied Electronics Section



Roma Tre University Roma, Italy









Department of Engineering Applied Electronics Section



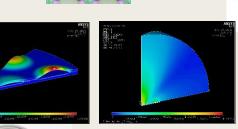
Acousto-Electronics Lab (ACULAB)



UNIROMA3 – our capabilities

20-Year Experience on Micromachined Ultrasonic Transducer Development: from Design to System Integration

- MEMS ultrasonic transducer
 Design
- FEM and system-level modeling
- Microfabrication and packaging
- Acoustic materials
- Characterization
- Electronic front-end circuit design
- Probe development
- Ultrasound imaging system integration





- 1998 MUT research started
 - 1999 Single-element CMUT transducer
 - 2003 64-element 1D probe First ultrasound imaging on clinical scanner
 - 2004 128-element 1D probe with embedded electronics
 - 2007 192-element 1D probe Reverse Fabrication Process
 - 2009 High frequency 192-element 1D probe
 - 2015 256-element 1D probe

- 2016 120+120-element
 2D row-column probe
- 2018 256-element
 2D array with ASIC AFE

UNIROMA3 – our planned contribution to WP4

UNIROMA3 will contribute to:

- PMUT transducer 1D and 2D array design (FEM for microstructure design and system-level modeling for electronics front-end/transducer co-design)
- Transducer packaging (definition of interconnection and encapsulation strategies)
- Transducer/electronics characterization (electromechanical, acoustic)
- ASIC design
- Probe development (design and assembly)

UNIROMA3 will mostly work together with:

- Philips
- STMicroelectronics
- University of Florence
- University of Pavia
- ...

Technische Universität Wien (TU Wien)



Radu Grosu Head of Cyber-Physical Systems Group

Muhammad Shafique

Head of Computer Architecture

and Robust Energy-Efficient

Technologies Group



Bharath Srinivas Prabakaran PhD Researcher

Research Interests:

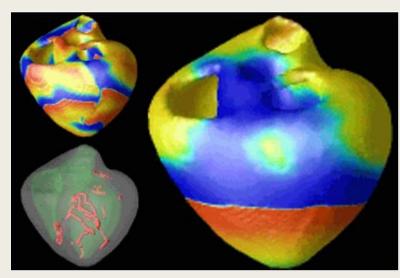
Prof. Dipl.-Ing. <u>Radu Grosu</u>: Computational Models in Systems Biology, Machine Learning, Modelbased Design, Logic and Automata Theory, Applications of Machine Learning Prof. Dr.-Ing. <u>Muhammad Shafique</u>: Applications of machine learning, HW/SW optimizations for ML Systems, Neuromorphic Computing, HW Architectures for ML



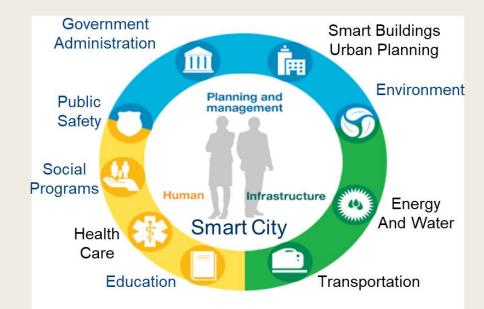
Research @ CPS

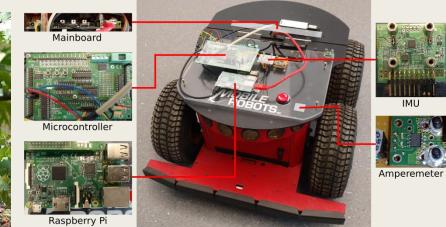
Smart Mobility

Neural Regulatory Networks
 Lane Tracking
 Smart Farming
 Smart Healthcare
 Machine Learning
 Industry 4.0









Research @ CARE-Tech

□ Brain-Inspired Computing

Deep Learning, Neuromorphic Systems
 Post-CMOS technologies

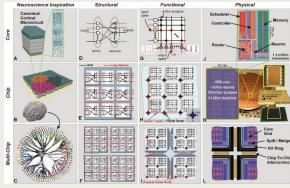
Low-Power sensor-processing for CPS/IoT
 In-memory computing, near-sensor processing
 On-Chips Systems for Smart Wearable Healthcare
 Robust embedded machine learning
 Reliability & Security of ML Systems

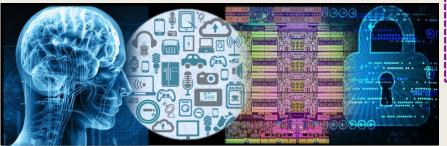


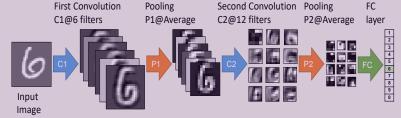




CNT diameter~1.2nm Sub-lithographic p Source: S. Mitra, P. Wong (Stanford), C. Mackin (MIT), J. Zhang (Google)







Source: IBM, TrueNorth Chip



TU Wien Planned Contributions



Moore4Medical Project Scope

Collaborators & Partners:



Next Generation Ultrasound



Data Acquisition
3D Reconstruction
Edge Processing

 Al algorithms for detecting fetus' anatomical features
 Hardware accelerator for high throughput feature extraction
 Closed-loop system for real-time user feedback

